

Form PTO-1595 (Rev. 07/05)
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RECORDATION FORM COVER SHEET PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)

Cheng C. Wang

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: Flex Logix Technologies, Inc.

Internal Address: _____

Street Address: 2465 Latham Street, Suite 100

City: Mountain View

State: _____

Country: California Zip: 94040

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) August 8, 2016

- Assignment Merger
- Security Agreement Change of Name
- Joint Research Agreement
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other _____

4. Application or patent number(s):

This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

15/213,933

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Neil A. Steinberg

Internal Address: _____

Street Address: 5335 Wisconsin Ave, NW Suite 440

City: Washington

State: D.C. Zip: 20015

Phone Number: 202-746-8133

Fax Number: 202-730-1249

Email Address: neils@swpatentlaw.com

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

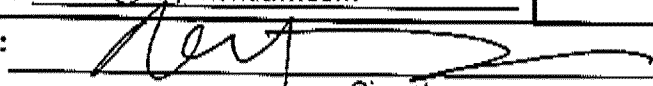
8. Payment Information

a. Credit Card Last 4 Numbers _____
Expiration Date _____

b. Deposit Account Number 50-0763

Authorized User Name Neil A. Steinberg

9. Signature:



Signature

August 8, 2016

Date

Neil A. Steinberg
Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
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PATENT

REEL: 039627 FRAME: 0568

ASSIGNMENT
(Docket No. 401.004-US)

Inventor: **Cheng C. Wang**

Application No.: **15/213,933**

Title: **Programmable Decoupling Capacitance
of Configurable Logic Circuitry and
Method of Operating Same**

Filing Date: **July 19, 2016**

I, the undersigned, in consideration of good and valuable considerations in hand paid, the receipt and sufficiency whereof are hereby acknowledged, hereby assign to

Flex Logix Technologies, Inc.

(2465 Latham Street, Suite 100, Mountain View, California), and its successors and assigns, the entire right, title and interest in: (i) the above-referenced patent application, and (ii) the inventions and/or improvements disclosed and/or claimed in the above-referenced patent application, and (iii) any and all other patent applications of the United States and foreign countries which claim priority to the above-referenced application and/or which may be filed, either solely or jointly with others, on the inventions and/or improvements disclosed and/or claimed in the above-referenced patent application, and (iv) any and all patents of the United States and foreign countries which may be obtained on any of the aforementioned applications, and (v) any reissue, reexamination or extension of such aforementioned patents, and further assign to said assignee the priority right provided by the International Convention.

I, the undersigned, hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patents to said assignee, its successors and assigns, in accordance with the terms of this Assignment.

I, the undersigned, hereby authorize and request the Assignee to insert in this instrument the filing date and application number of the application when ascertained.

I, the undersigned, warrant that there are no outstanding prior assignments, licenses, or other encumbrances on the interests herein assigned, other than those assignments, licenses, or other encumbrances already assigned to **Flex Logix Technologies, Inc.**

I, the undersigned, for said considerations hereby agree, upon the request and at the expense of said assignee, its successors and assigns, to execute any and all divisional,

continuation and substitute applications for said inventions and/or improvements, and any necessary oath, affidavit or declaration relating thereto, and any application for the reissue, reexamination or extension of any patents that may be granted on said application and any and all applications and other documents for patents in foreign countries on said inventions and/or improvements, that said assignee, its successors or assigns may deem necessary or expedient, and for the said considerations the undersigned authorize said assignee to apply for patents for said inventions and/or improvements in its own name in such countries where such procedure is proper and further agree, upon the request of said assignee, its successors and assigns, to cooperate to the best of the ability of the undersigned with said assignee, its successors and assigns, in any proceedings or transactions involving such applications or patents, including the preparation and execution of preliminary statements, giving and producing evidence, and performing any and all other acts necessary to obtain said patents, both United States and foreign, and vest all rights therein hereby conveyed in the assignee, its successors and assigns, whereby all said patents will be held and enjoyed by the said assignee, its successors and assigns, to the full end of the term for which said patents will be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment had not been made.

Date: August 8, 2016



Cheng C. Wang